

Booth #3241

ELSFP External Laser Small Form Factor Pluggable

Eliminate CPO switch downtime with modular 'hot-swappable' laser sources

The External Laser Small Form-Factor Pluggable (ELSFP) is a pioneering blind-mating optical and electrical interconnect in a convenient pluggable industry recognized OSFP-RHS approximate footprint. The ELSFP is optimized to support next-generation co-packaged optics (CPO) requiring a remote laser source.

Module and Host Connectors

SENKO's innovative design allows the laser module to be quickly and easily 'blind-mated' to the host connectors mounted within the CPO switch.

MODULE CONNECTOR

INTEROP DEMO

HOST CONNECTOR



SENKO's SN-MT32

Connectivity optimizes patch panel densification and enables the front panel space for the ELSFP modules.

FEATURES

- Reduced overall system thermal power density
- Fast 'plug & play' design for fast deployment
- Compact design enables maximum face-plate density
- A single ELSFP can support multiple OEs
- Hot swappable to prevent system downtime
- Eye-safe design
- Approximate OSFP-RHS envelope
- PM fiber assemblies for the interconnect between
- ELSFP and CPO engines

OFC 2024 www.oiforum.com

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Hyperscale

sification with



SN-MT Mini MBMC Adapter

Metallic PIC Connector

For Onboard Interconnect

FEATURES

- 12/16/24-fiber per ferrule
- For SM and PM fiber
- 28.5 mm L x 4.9 mm W x13 mm H
- Stackable design for multi-port applications



SN®-MT Mini MBMC Adapter

SN®-MT

Mini MBMC Adapter

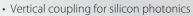
Stacked Horizontally

mirror array

SN®-MT Mini MBMC Connector

thermally-stable frame

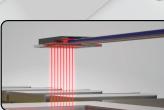
> Metallic PIC 20CH 127µm pitch



- Connecting fibers to laser arrays
- Connections for receiver arrays
- Beam expansion

MPC

- Thermal stability
- Reflowable design
- Low profile
- Mirrors are a customizable optical design



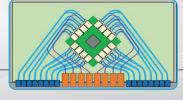
stamped aluminum

groove array

127µm pitch MOB: metallic optical bench aspherical mirror optical fiber glass cover optical I/O silicon photonic chip

Fiber Assemblies

- Single mode fiber assemblies for fiber routing between faceplate and CPO engines
- Multiple fiber counts available to support both FR and DR types of optics
- PM fiber assemblies for the interconnect between ELSFP and CPO engines





MT Ferrules MT ferrule assemblies with PM fibers meeting ELSFP requirements

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Scan the QR code to learn more



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